

High-Voltage — High Power Transistors

. . . designed for use in high power audio amplifier applications and high voltage switching regulator circuits.

• High Collector–Emitter Sustaining Voltage —

NPN PNP

V_{CEO(sus)} = 160 Vdc — MJE4343 MJE4353

• High DC Current Gain — @ I_C = 8.0 Adc

 $h_{FE} = 35 \text{ (Typ)}$

• Low Collector–Emitter Saturation Voltage —

 $V_{\text{CE(sat)}} = 2.0 \text{ Vdc (Max)} @ I_{\text{C}}$ = 8.0 Adc

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Collector–Emitter Voltage	V _{CEO}	160	Vdc
Collector–Base Voltage	V _{CB}	160	Vdc
Emitter–Base Voltage	V _{EB}	7.0	Vdc
Collector Current — Continuous Peak (1)	lc	16 20	Adc
Base Current — Continuous	Ι _Β	5.0	Adc
Total Power Dissipation @ T _C = 25°C	P_{D}	125	Watts
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$	1.0	°C/W

(1) Pulse Test: Pulse Width $\leq 5.0 \,\mu s$, Duty Cycle $\geq 10\%$.

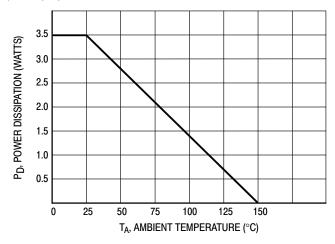
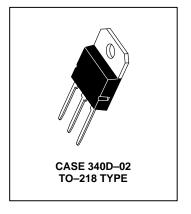


Figure 1. Power Derating Reference: Ambient Temperature

MJE4343 PNP MJE4353

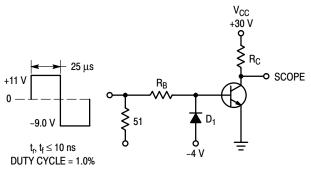
16 AMPERE
POWER TRANSISTORS
COMPLEMENTARY
SILICON
160 VOLTS



ELECTRICAL CHARACTERISTICS ($T_C = 25$ °C unless otherwise noted)

Symbol	Min	Max	Unit
		•	
V _{CEO(sus)}	160	_	Vdc
I _{CEO}	_	750	μAdc
ICEX	_	1.0 5.0	mAdc
I _{CBO}	_	750	μAdc
I _{EBO}	_	1.0	mAdc
h _{FE}	15 8.0	35 (Typ) 15 (Typ)	_
V _{CE(sat)}	-	2.0 3.5	Vdc
V _{BE(sat)}	_	3.9	Vdc
V _{BE(on)}	_	3.9	Vdc
		•	
f _T	1.0	_	MHz
C _{ob}	_	800	pF
	VCEO(sus) ICEO ICEX ICBO IEBO VCE(sat) VBE(sat) VBE(on)	VCEO(sus) 160 ICEO	VCEO(sus) 160 — ICEO — 750 ICEX — 1.0 ICBO — 750 IEBO — 1.0 VCE(sat) — 35 (Typ) NO 15 (Typ) 15 (Typ) VBE(sat) — 3.9 VBE(on) — 3.9

⁽¹⁾ Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \geq 2.0%. (2) $f_T = |h_{fe}| \bullet f_{test}$.



 R_B and R_C VARIED TO OBTAIN DESIRED CURRENT LEVELS D_1 MUST BE FAST RECOVERY TYPE, e.g.: 1N5825 USED ABOVE $I_B\approx 100$ mA MSD6100 USED BELOW $I_B\approx 100$ mA

Note: Reverse polarities to test PNP devices.

3.0 $T_J = 25^{\circ}C$ 2.0 $I_C/I_B = 10$ V_{CE} = 30 V 1.0 0.7 t, TIME (µs) 0.5 0.3 0.2 0.1 $t_d @ V_{BE(off)} = 5.0 V$ 0.07 0.05 0.03 0.2 0.3 0.5 0.7 1.0 5.0 7.0 20 I_C, COLLECTOR CURRENT (AMP)

Figure 3. Typical Turn-On Time

Figure 2. Switching Times Test Circuit

TYPICAL CHARACTERISTICS

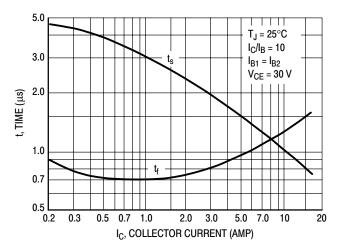


Figure 4. Turn-Off Time

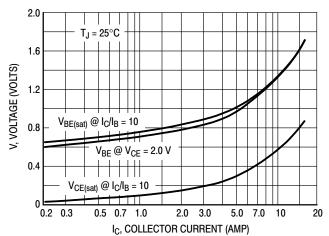


Figure 5. On Voltages

DC CURRENT GAIN

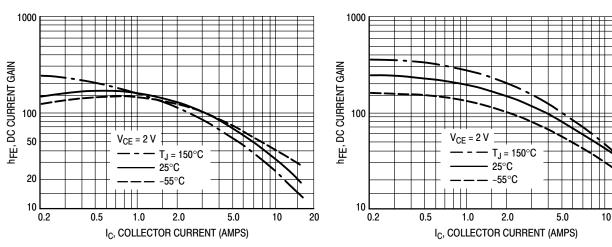


Figure 6. MJE4340 Series (NPN)

Figure 7. MJE4350 Series (PNP)

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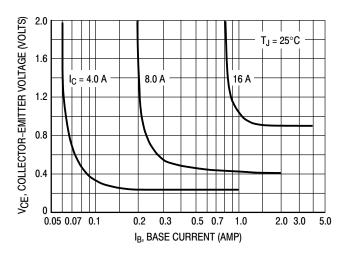


Figure 8. Collector Saturation Region

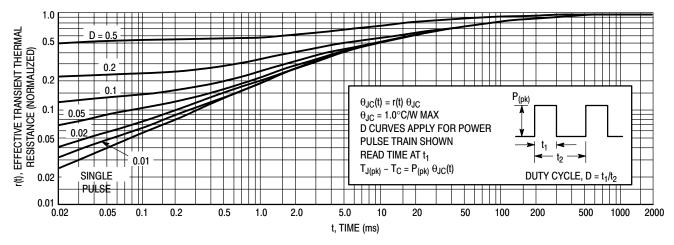


Figure 9. Thermal Response

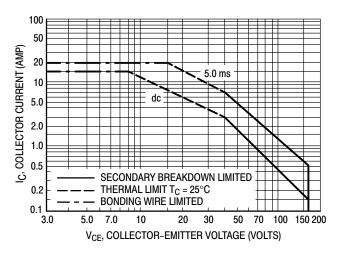


Figure 10. Maximum Forward Bias Safe Operating Area

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 11 gives RBSOA characteristics.

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 10 is based on $T_C = 25^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \ge 25^{\circ}C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 10 may be found at any case temperature by using the appropriate curve on Figure 9.

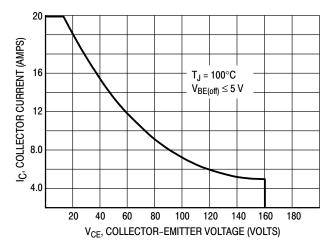
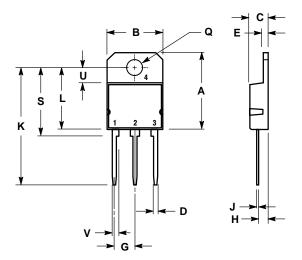


Figure 11. Maximum Reverse Bias Safe
Operating Area

PACKAGE DIMENSIONS

CASE 340D-02 **ISSUE E**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α		20.35		0.801
В	14.70	15.20	0.579	0.598
С	4.70	4.90	0.185	0.193
D	1.10	1.30	0.043	0.051
E	1.17	1.37	0.046	0.054
G	5.40	5.55	0.213	0.219
Н	2.00	3.00	0.079	0.118
J	0.50	0.78	0.020	0.031
K	31.00 REF		1.220 REF	
L		16.20		0.638
Q	4.00	4.10	0.158	0.161
S	17.80	18.20	0.701	0.717
U	4.00 REF		0.157 REF	
٧	1.75 REF		0.069	

- STYLE 1:
 PIN 1. BASE
 2. COLLECTOR
 3. EMITTER
 4. COLLECTOR



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